502361779 05/28/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Satoshi OZAWA	02/28/2013
Syuuzi ITOH	02/28/2013
Haruo TAGUCHI	02/27/2013

RECEIVING PARTY DATA

Name:	TDK CORPORATION
Street Address:	1-31-1, Nihonbashi
City:	Chuo-ku, Tokyo
State/Country:	JAPAN
Postal Code:	103-8272

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13750517

CORRESPONDENCE DATA

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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ATTORNEY DOCKET NUMBER:	108179.00095
NAME OF SUBMITTER:	Eugene Benjamin
Signature:	/Eugene Benjamin/
Date:	05/28/2013

Total Attachments: 1

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PATENT

REEL: 030493 FRAME: 0777

Docket No.	

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

[Insert ASSIGNEE's Nanic(s) Address(es)] TDK CORPORATION

1-13-1, Nihonbashi

Chuo-ku, Tokyo, 103-8272, JAPAN

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest, including the right to sue for past infringement, if any, and all rights pursuant to 35 U.S.C. §154, to the invention entitled

[Title of Invention]

LAMINATED PIEZOELECTRIC DEVICE

[*If the assignment is being filed after the filing of the application, this section must be completed] for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on

January 25, 2013

__ , Serial No.

13/750517

(Arent Fox LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof, and any other application claiming priority thereto, for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s) of Assignor(s)]

Sateski Ozawa	Satoshi OZAWA	2013,02,28
S.I. (SIGNATURE)	(TYPE NAME)	(DATE)
S.I. (SIGNATURE) 2013.02.28 Symuzi Itch	Syuuzi ITOH	2013.02.28
(SIGNATURE)	(TYPE NAME)	(DATE)
	Haruo TAGUCHI	2013.02.27
Harrio Taguilia (SIGNAPURE)	(TYPE NAME)	(DATE)
(SIGNATURE)	(TYPE NAME)	(DATE)
(SIGNATURE)	(TYPE NAME)	(DATE)
(SIGNATURE)	(TYPE NAME)	(DATE)

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